

2815

PATENT

Case Docket No. MICRON.170A

Date: April 4, 2002

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ORIGINALLY FILED

In re application of : Paul A. Farrar)
 App. No. : 09/909,181)
 Filed : July 19, 2001)
 For : METHOD OF USING)
 FOAMED INSULATORS IN)
 THREE DIMENSIONAL)
 MULTIPCHIP STRUCTURES)
 Examiner : Chris C. Chu)
 Art Unit : 2815)

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Michael H. Trenholm, Reg. No. 37,743

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Sir:

Transmitted herewith is a Response to Restriction Requirement in the above-identified application.

The fee has been calculated as shown below:

CLAIMS AS FILED

CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims 26 — 32		= 0 ×	\$18	= \$0
Independent Claims 2 — 3		= 0 ×	\$84	= \$0

If application has been amended to contain multiple dependent claim(s), then add \$280 = \$0

Time Extension Fee \$0

TOTAL ADDITIONAL FEE
FOR THIS AMENDMENT \$0

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Michael H. Trenholm
Registration No. 37,743
Attorney of Record